

Part Number Marking
HGA093N12SL GA093N12SL

$V_{GS}=4.5V$ 9.5 m
 44 A

Absolute Maximum Ratings at $T_J=25^\circ\text{C}$ (unless otherwise specified)

	Symbol	Conditions	Value	Unit
Continuous Drain Current (Silicon Limited)	I_D	$T_C=25^\circ\text{C}$	44	A
		$T_C=100^\circ\text{C}$	31	
Drain to Source Voltage	V_{DS}	-	120	V
Gate to Source Voltage				
Pulsed Drain Current		-	250	
Avalanche Energy, Single Pulse				
Operating and Storage Temperature	T_J, T_{stg}	-	-55 to 175	

Parameter	Symbol	Unit
Thermal Resistance Junction-Ambient	R_{JA}	$^\circ\text{C}/\text{W}$
Thermal Resistance Junction-Case	R_{JC}	$^\circ\text{C}/\text{W}$

Gate Resistance	R_G	$V_{DS}=5V, I$ $V_{GS}=0V, V_{DS}$ Open, $f=1MHz$	-	70	-	S
			-	1	-	

Input Capacitance	C_{iss}	-	2626	-		
Output Capacitance	C_{oss}	$V_{GS}=0V, V_{DS}=60V, f=1MHz$	-	329	-	pF
	C_{rss}		-	11	-	
Total Gate Charge	$Q_g(10V)$		-	38	-	
Total Gate Charge	$Q_g(4.5V)$		-	18	-	nC
Gate to Source Charge	Q_{gs}	$V_{DD}=60V, I_D=20A, V_{GS}=10V$	-	7	-	
Gate to Drain (Miller) Charge	Q_{gd}		-	5	-	
Turn on Delay Time	$t_{d(on)}$		-	13	-	
Rise time	t_r	$V_{DD}=60V, I_D=20A, V_{GS}=10V,$	-	7	-	ns
Turn off Delay Time	$t_{d(off)}$	$R_G=10 \Omega$	-	22	-	
Fall Time	t_f		-	9	-	

Reverse Diode Characteristics

Diode Forward Voltage	V_{SD}	$V_{GS}=0V, I_F=20A$	-	0.9	1.2	V
Reverse Recovery Time	t_{rr}	$V_R=60V, I_F=20A, dI_F/dt=100A/ s$	-	53	-	ns
Reverse Recovery Charge	Q_{rr}		-	58	-	nC

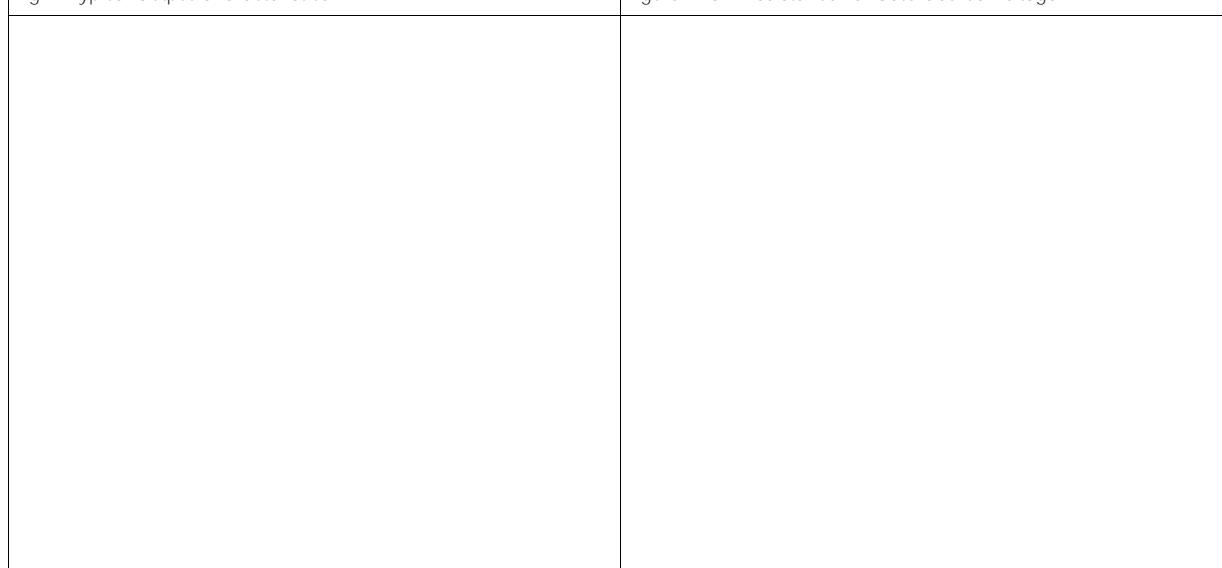
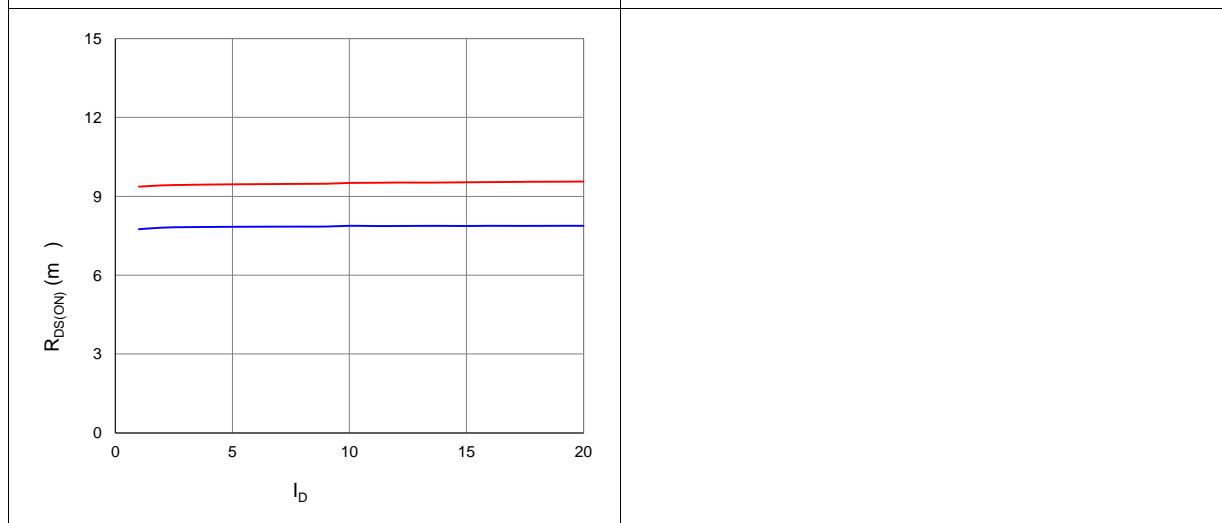
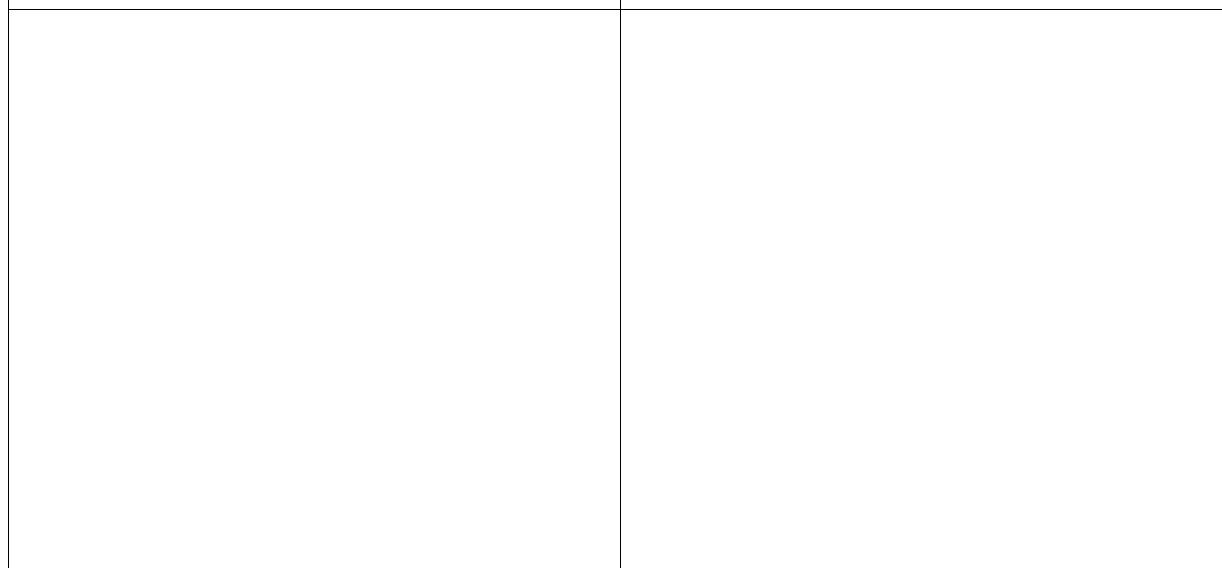
Fig 1. Typical Output Characteristics
Figure 2. On-Resistance vs. Gate-Source Voltage

Figure 3. On-Resistance vs. Drain Current and Gate Voltage
Figure 4. Normalized On-Resistance vs. Junction Temperature

Figure 5. Typical Transfer Characteristics
Figure 6. Typical Source-Drain Diode Forward Voltage


Figure 7. Typical Gate-Charge vs. Gate-to-Source Voltage

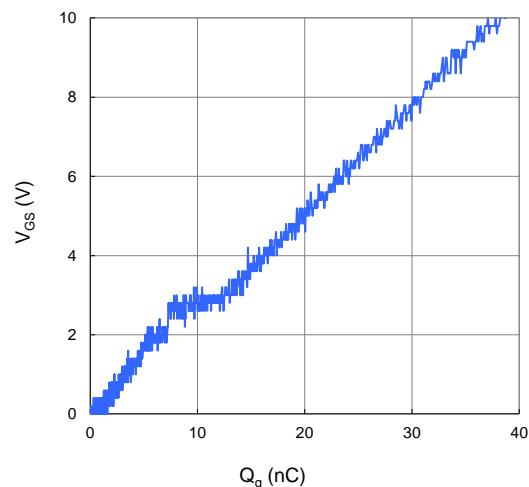


Figure 8. Typical Capacitance vs. Drain-to-Source Voltage

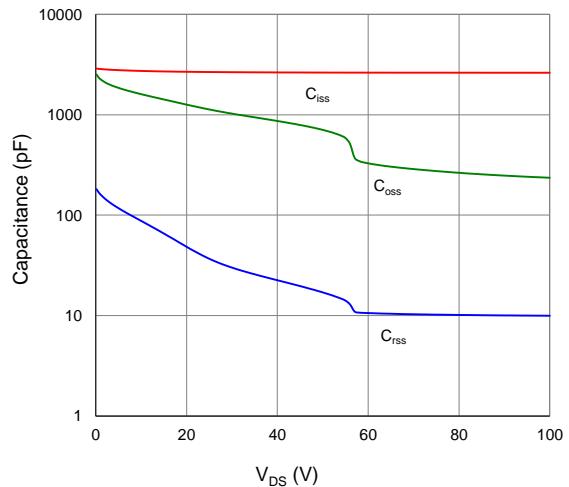


Figure 9. Maximum Safe Operating Area

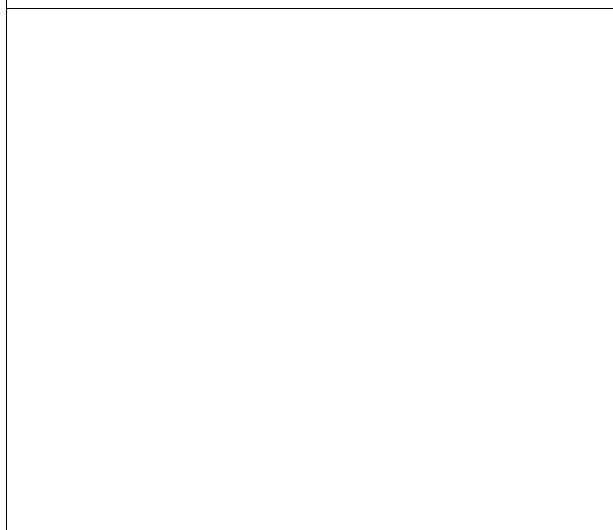
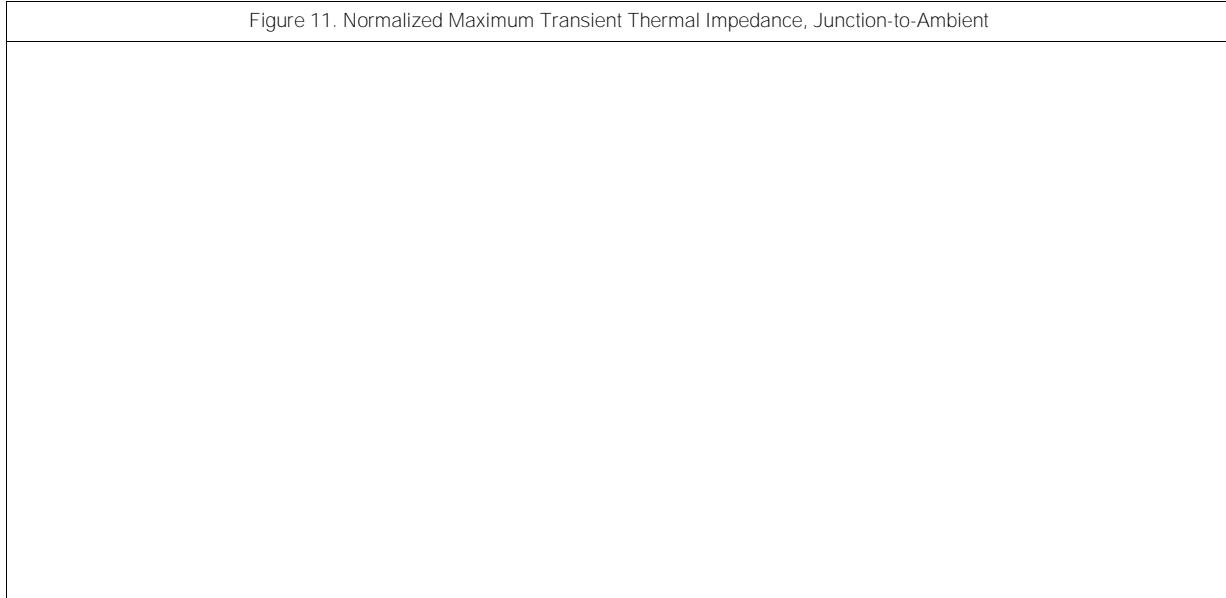
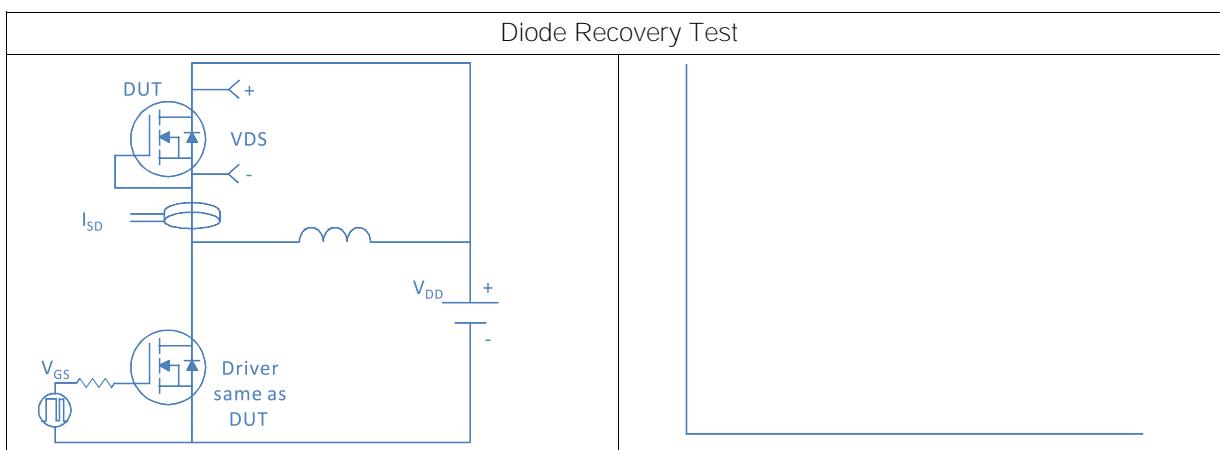
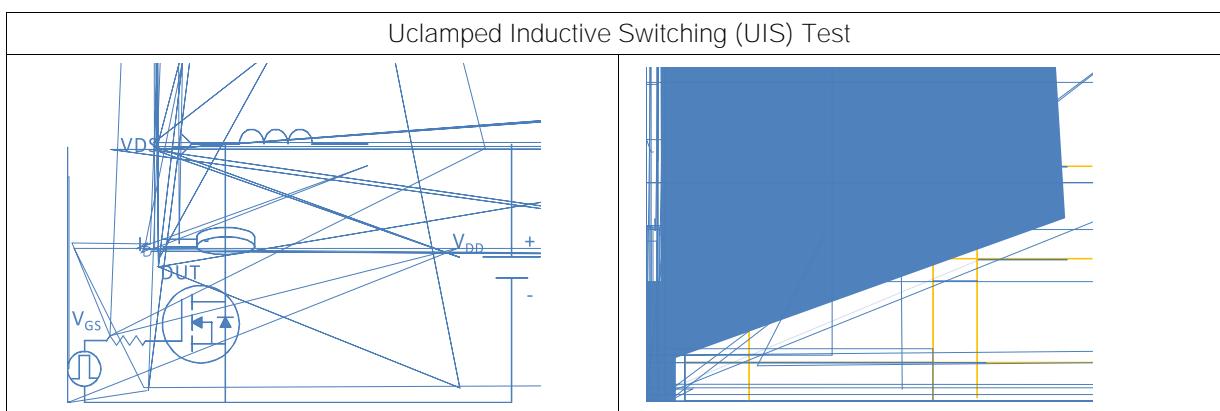
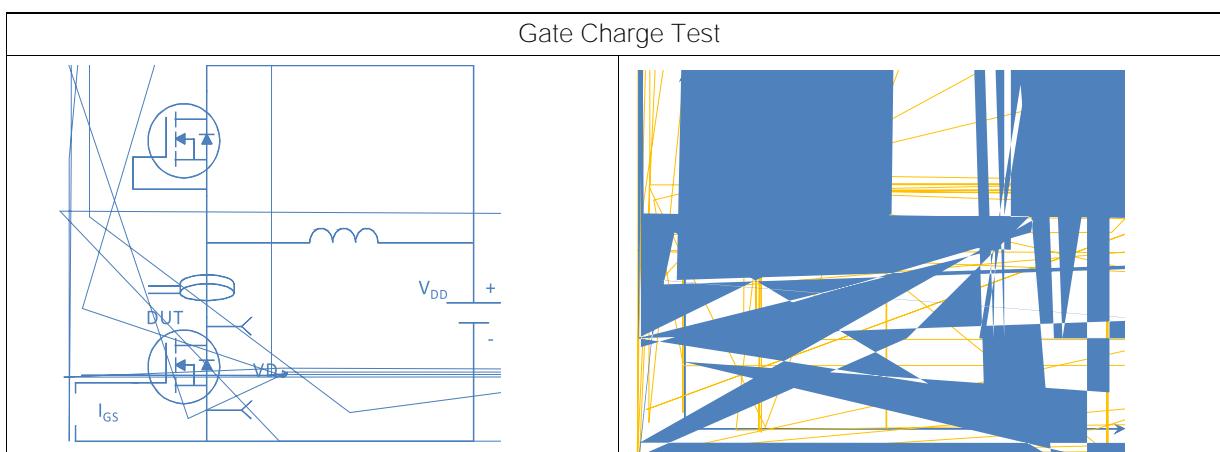
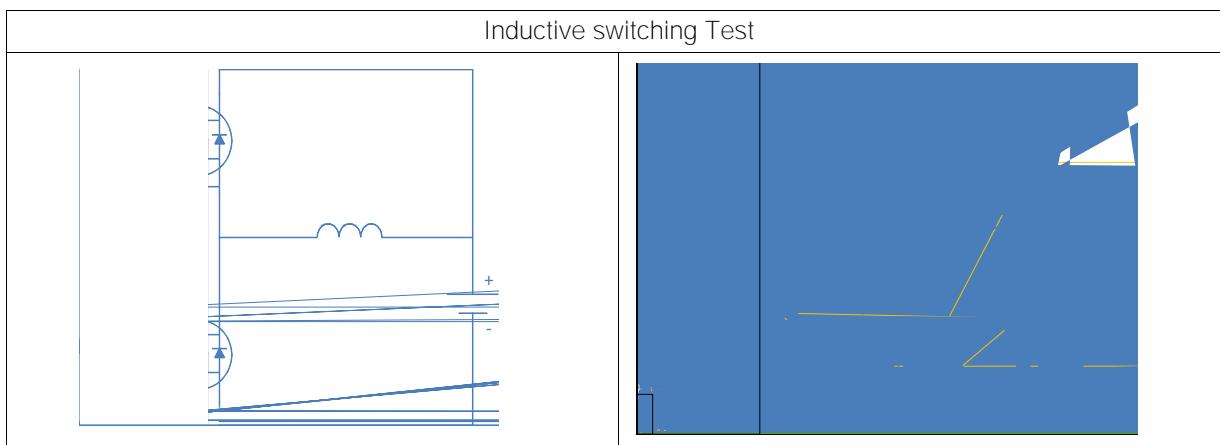


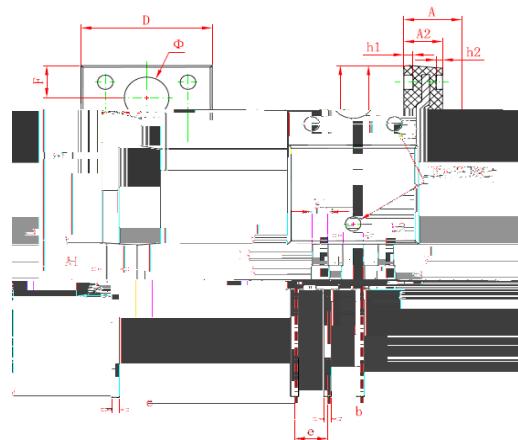
Figure 10. Maximum Drain Current vs. Case Temperature



Figure 11. Normalized Maximum Transient Thermal Impedance, Junction-to-Ambient





Package Outline
TO-220F, 3 leads


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	4.300	4.700	0.169	0.185
A1	1.300	REF.	0.051	REF.
B1	1.120	1.380	0.048	0.055
C1	0.530	0.560	0.021	0.025
C2	0.400	0.460	0.016	0.018
C3	0.690	14.000	0.260	0.663
C4	0	2.840	0.112	0
C5	0	2.700	0.106	0
C6	0	3.900	0.154	0
C7	0.012	0.000	0.000	0.000
C8	0	0.000	0.000	0
C9	0	0.000	0.000	0
D1	1.110	1.1	0.043	0.044
D2	0.976	1.1	0.038	0.040
D3	0.083	1.2	0.003	0.006